	RECORDATION FORM COVER SHEET PATENTS ONLY		
To the Assistant Commissioner for Patents. Please record the attached	d original documents or copy thereof.		
Name of conveying party(ies):	Name and Address of receiving party(les):		
Kazuaki Ano 9/7/05	Name: TEXAS INSTRUMENTS INCORPORATED		
	Address: P.O. Box 655474, MS 3999		
	City: Dallas		
	State: T)	C Zip: 75265	
	Additional name(s) & address(es) attac	ched?Yes _X_ No	
3. Nature of Conveyance:			
X_ Assignment Merger			
Security Agreement Change of Name			
Other			
Execution Date in order of listed parties: 9/7/05			
Application number(s) or patent number(s). This degrees is being filed together with a pow application.			
This document is being filed together with a new application.			
Execution date of the application in order of listed parties: 9/7/05 Title: Semiconductor Device Having Improved Mechanical and Thermal Docket No: TI-61140	Reliability		
A. Patent Application No.(s) S.N. 11/201,717	B. Patent No.(s) X,XXX,XXX		
Additional numbers attached? YesX No	Additional numbers attach	ed? YesX_ No	
Name and address of party to whom correspondence concerning document should be mailed:	6. Number of applications and patents	involved:(1)	
Name: Yingsheng Tung Texas Instruments Incorporated			
Address: P.O. Box 655474, MS 3999			
City: Dallas			
State: TX Zip: 75265		****	
	7. Amount of fee enclosed or authorized to be charged: \$40		
	Deposit Account No: 20-0668 (Att paying by deposit account)	tach duplicate copy if	
DO NOT	USE THIS SPACE		
Бокот	44= 1194 At 1/4F		
9. Statement and signature.		\cap	
To the best of my knowledge and belief, the foregoing information is true	e and correct and any attached copy is a true	copy of the original document.	
9-15-2005	A STOR	Jan Jun	
	/ 10 -1 -	ω_{1} / 1 1 1 1	

PATENT REEL: 016807 FRAME: 0808 TI-61140

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Semiconductor Device Having Improved Mechanical and Thermal Reliability				
SIGNATURE OF INVENTOR AND NAME	Kazuaki Ano) N/A	n/A		
DATE OF SIGNATURE	× Sep-07-05				
RESIDENCE (City, State)	Cita-pref, Japan				
DATE APPLICATION EXECUTED					

After recording Assignment, please return to:

RECORDED: 09/15/2005

Yingsheng Tung Texas Instruments Incorporated P.O. Box 655474, MS 3999 Dallas, TX 75265

> PATENT REEL: 016807 FRAME: 0809